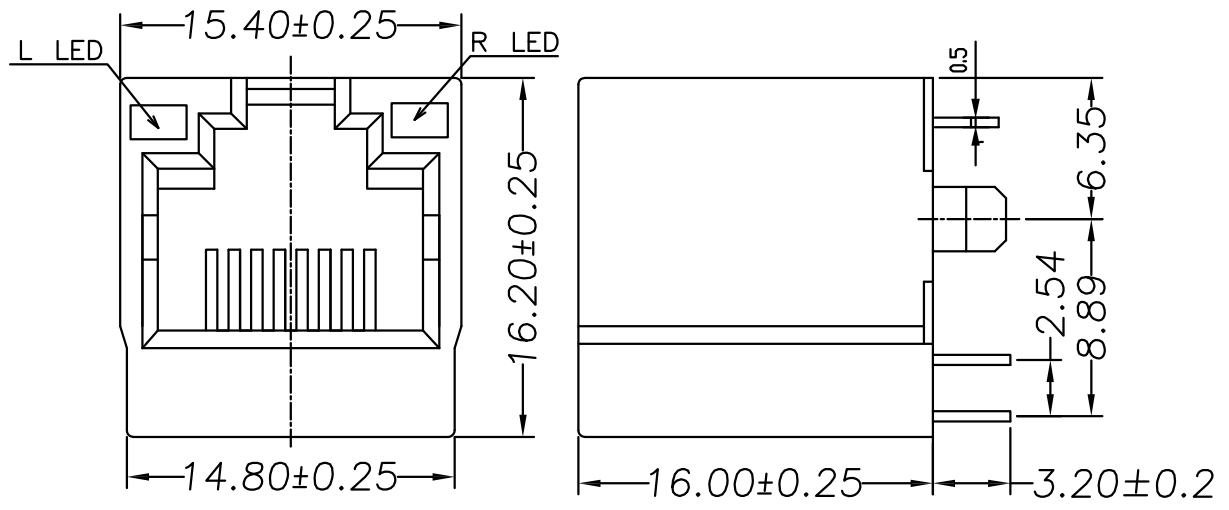
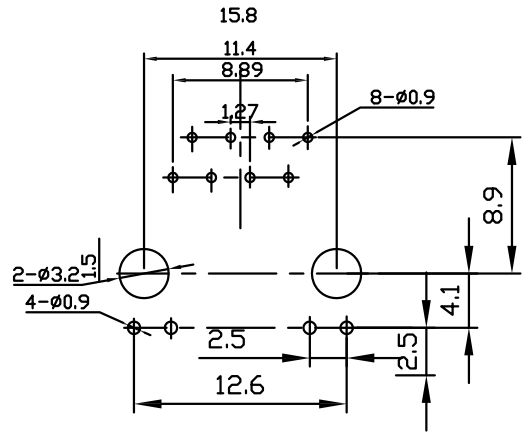


REV.	ECN.NO.	APPD.
A	/	/



NOTES:

- 1.MATERIAL:
 - 1.1 Housing:thermoplastic plastics
 - 1.2 terminals:Copper Alloy
Gold plated in contact area:
OR Gold Plated overall
 - 1.3 Shell:Steel&Copper Alloy
Nickel/Tin Plated overall
- 2.ELECTRICAL CHARACTERISTICS:
 - 2.1 Rating Current :1.5 Ampere
 - 2.2 Rating Voltage :125 V Max
 - 2.3 Contact Resistance:50 Milli ohms
 - 2.4 Insulation Resistance:500 Mega ohms Min.
- 3.MECHANICAL CHARACTERISTICS:
 - 3.1 Connector Mating force: 2.27kgf MAX
 - 3.2 Durability:750Cycles.
- 4.ENVIRONMENT CHARACTERISTICS:
 - 4.1 Operating temperature:-40°C to +85°C
 - 4.2 Storage temperature:-10°C to +40°C



(建议板后1.6mm)
PC Board Layout

R5F0-1302F-G31018

G:半金G/F
1:吸塑盒
3:PA46
1:黑色

TOLERANCE UNLESS OTHERWISE SPECIFIED		FLW 深圳市华联威电子科技有限公司					
.XXX ±0.30	.XX ±0.20	.X ±0.10	.X' ±5'			HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.	
APPROVED		PART NAME:		RJ45 180° 直插全塑8P8C			
CHECKED		PART No:		R5F0-1302F-G31018	C		
DRAWN	Shen	PROJECTION:	UNIT:	SCALE:	SHEET:	REV.	
DATE	2021.09.01		mm	1:1	10F1	A	